PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SHIN SOYANO	04/20/2015
YOSHIKAZU TAKAMIYA	04/20/2015
TORU YAMADA	04/20/2015
RYO MARUYAMA	04/20/2015

RECEIVING PARTY DATA

Name:	FUJI ELECTRIC CO., LTD.	
Street Address:	1-1 TANABESHINDEN, KAWASAKI-KU	
City:	KAWASAKI-SHI, KANAGAWA	
State/Country:	JAPAN	
Postal Code:	210-9530	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	29531129

CORRESPONDENCE DATA

Fax Number: (248)649-3338

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 2486493333

Email: donovan@youngbasile.com
Correspondent Name: MICHELLE L. KNIGHT

Address Line 1: 3001 WEST BIG BEAVER ROAD

Address Line 2: SUITE 624

Address Line 4: TROY, MICHIGAN 48084

ATTORNEY DOCKET NUMBER:	MOR-329-A	
NAME OF SUBMITTER:	MICHELLE L. KNIGHT	
SIGNATURE:	/Michelle L. Knight/	
DATE SIGNED:	06/24/2015	

Total Attachments: 2

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PATENT 503364063 REEL: 035894 FRAME: 0533

Our Reference: MOR-329-A

ASSIGNMENT

WHEREAS, I/we

- 1) Shin SOYANO, 2) Yoshikazu TAKAMIYA, 3) Toru YAMADA, and
- 4) Ryo MARUYAMA, residing at

Tokyo, JAPAN, respectively,

have invented an

SEMICONDUCTOR MODULE

for which we are about to make application for Letters Patent of the United States of America; and

WHEREAS,

FUJI ELECTRIC CO., LTD.,

a corporation of **JAPAN** having its principal place of business at

1-1, Tanabeshinden, Kawasaki-ku, Kawasaki-shi, Kanagawa 210-9530 JAPAN

desires to acquire the entire right, title and interest in and to said invention.

NOW, THEREFORE, for and in consideration of the sum of One Dollar (\$1.00) and other good and valuable considerations, receipt whereof is hereby acknowledged, we, by these presents do sell, assign, and transfer unto said corporation, its successors and assigns, all right, title and interest in the United States of America and all foreign countries in and to said invention as described in the patent application executed by us on the 20th day of April , 2015 , and we hereby authorize our attorneys, authorized to prosecute said application, to here insert the filing date and serial of said application, as soon as it is known, Serial No. 29/531,129, filed June 23,2015 ___, and to any improvements on said invention heretofore or hereafter made while we are in the employ of said corporation, and any divisions or continuations of said application, and all Patents, United States and foreign, granted upon any such applications or for the inventions described therein, and any reissues or extensions of said Patents; and we hereby authorize and request the Commissioner of Patents and Trademarks to issue all Patents

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on said United States applications to said corporation as assignee thereof.

FOR SAID CONSIDERATIONS, we hereby covenant and agree that we are the owners of the full title herein assigned and have the right to assign the same, and agree that we will communicate to said corporation or its representatives, any facts known to us respecting said invention or inventions and testify in any legal proceedings relating thereto when called upon, and will sign all instruments and documents and render such assistance which in the judgment of said corporation is necessary to vest in it and protect the legal title sought to be assigned.

Shin SOYANO

Yoshikazu TAKAMIYA

Shin Soyano yosikazu Jakamiya

Date: april 20, 2015

Date: april 20, 2015

Toru YAMADA

Ryo MARUYAMA

Date: april 20, 2015

Ryo Moruyama

Date: april 20, 2015